

MOSFET

OptiMOS[™] 6 Power-Transistor, 120 V

Features

- N-channel, logic level
- Very low on-resistance R_{DS(on)}
- Excellent gate charge x R_{DS(on)} product (FOM) Very low reverse recovery charge (Q_{rr})
- · High avalanche energy rating
- 175°C operating temperature
- Optimized for high frequency switching and synchronous rectification
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

- MSL 1 classified according to J-STD-020



Fully qualified according to JEDEC for Industrial Applications

Key Performance Parameters Table 1

<u> </u>							
Parameter	Value	Unit					
V _{DS}	120	V					
R _{DS(on),max}	10.6	mΩ					
I_{D}	62	Α					
Qoss	37	nC					
Q _G (0V4.5V)	10.4	nC					
Q _{rr} (1000A/µs)	106	nC					











Type / Ordering Code	Package	Marking	Related Links
ISZ106N12LM6	PG-TSDSON-8	10612L6	-

OptiMOS[™] 6 Power-Transistor, 120 V ISZ106N12LM6



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OptiMOS[™] 6 Power-Transistor, 120 V ISZ106N12LM6



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Damamatan	Symab al	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	62 44 38 10	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =60°C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	248	Α	<i>T</i> _A =25 °C
Avalanche current, single pulse ⁴⁾	I _{AS}	-	-	28	Α	T _C =25 °C
Avalanche energy, single pulse	E AS	-	-	277	mJ	$I_{\rm D}$ =6 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	94 2.5	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 °C/W ²⁾
Operating and storage temperature	$T_{\rm j},~T_{\rm stg}$	-55	-	175	°C	-

2 Thermal characteristics

Table 3 Thermal characteristics

Downwotor	Cumbal	Values			l lmi4	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	1.6	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area²)	R _{thJA}	-	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

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Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 **Static characteristics**

Danamatan	Connection 1		Values	3		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	120	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	1.2	1.7	2.2	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=35\ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1.0 100	μΑ	V _{DS} =100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =100 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	- - -	8.9 11.6 16.8	10.6 14.2 -	mΩ	V _{GS} =10 V, I _D =28 A V _{GS} =4.5 V, I _D =14 A V _{GS} =3.3 V, I _D =4.6 A
Gate resistance	R _G	0.48	0.96	1.44	Ω	-
Transconductance	g fs	28	56	-	S	V _{DS} ≥2 <i>I</i> _D <i>R</i> _{DS(on)max} , <i>I</i> _D =28 A

Table 5 **Dynamic characteristics**

Parameter	Ob. a.l		Values			Nata / Tank One distant
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	C _{iss}	-	1400	1800	pF	V _{GS} =0 V, V _{DS} =60 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	340	440	pF	V _{GS} =0 V, V _{DS} =60 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	10	17	pF	V _{GS} =0 V, V _{DS} =60 V, <i>f</i> =1 MHz
Turn-on delay time	t _{d(on)}	-	6	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =14 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	2.5	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =14 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	14	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =14 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	4	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =14 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Cumbal		Values			Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge ¹⁾	Q _{gs}	-	4	5.3	nC	V _{DD} =60 V, I _D =14 A, V _{GS} =0 to 4.5 V
Gate charge at threshold ¹⁾	Q _{g(th)}	-	2.5	3.3	nC	V _{DD} =60 V, I _D =14 A, V _{GS} =0 to 4.5 V
Gate to drain charge ¹⁾	Q_{gd}	-	3.5	5.3	nC	V _{DD} =60 V, I _D =14 A, V _{GS} =0 to 4.5 V
Switching charge	Q _{sw}	-	5	-	nC	V _{DD} =60 V, I _D =14 A, V _{GS} =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	10.4	13	nC	V_{DD} =60 V, I_{D} =14 A, V_{GS} =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.8	-	V	V _{DD} =60 V, I _D =14 A, V _{GS} =0 to 4.5 V
Gate charge total ¹⁾	Q_g	-	19.6	26	nC	V_{DD} =60 V, I_{D} =14 A, V_{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	37	49	nC	V _{DS} =60 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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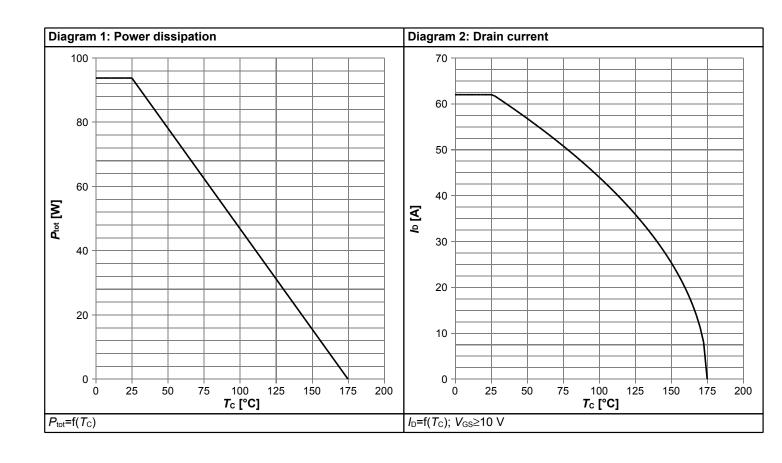


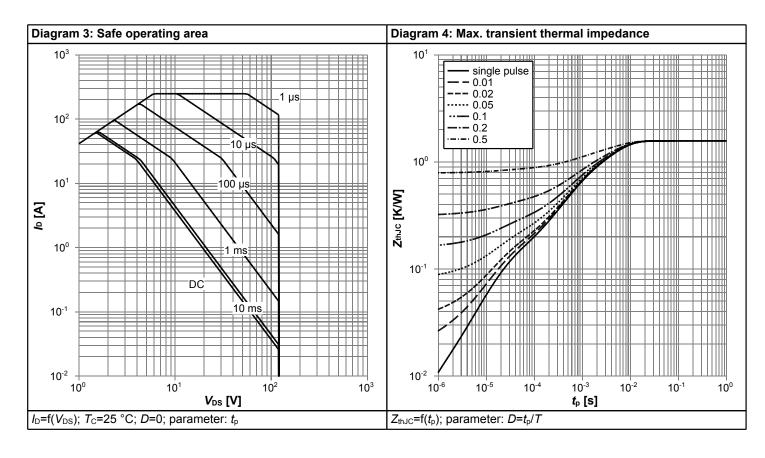
Table 7 Reverse diode

Damamatan	Cross al		Values			Nata / Tank Canadikian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	62	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	248	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.87	1.0	V	V _{GS} =0 V, I _F =28 A, T _j =25 °C
Reverse recovery time ¹⁾ t_{rr}		-	23	46	ns	V _R =60 V, I _F =14 A, di _F /dt=300 A/μs
Reverse recovery charge ¹⁾	Qrr	-	38	76	nC	V _R =60 V, I _F =14 A, di _F /dt=300 A/μs
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	17	34	ns	V _R =60 V, I _F =14 A, di _F /dt=1000 A/μs
Reverse recovery charge ¹⁾	Q _{rr}	-	106	212	nC	V _R =60 V, I _F =14 A, di _F /dt=1000 A/µs

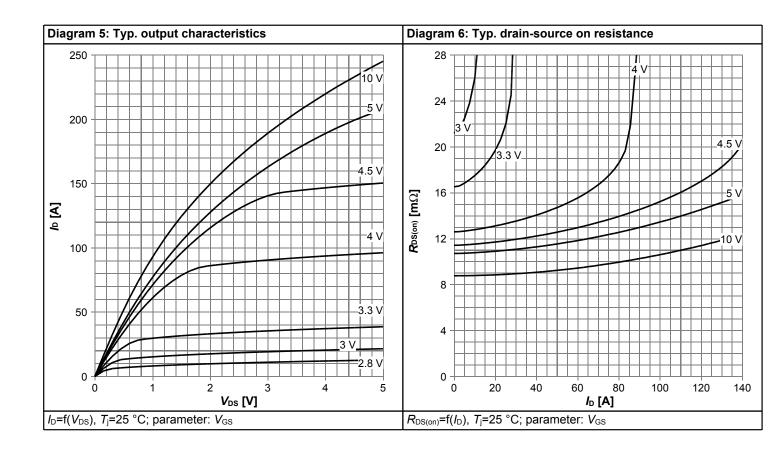


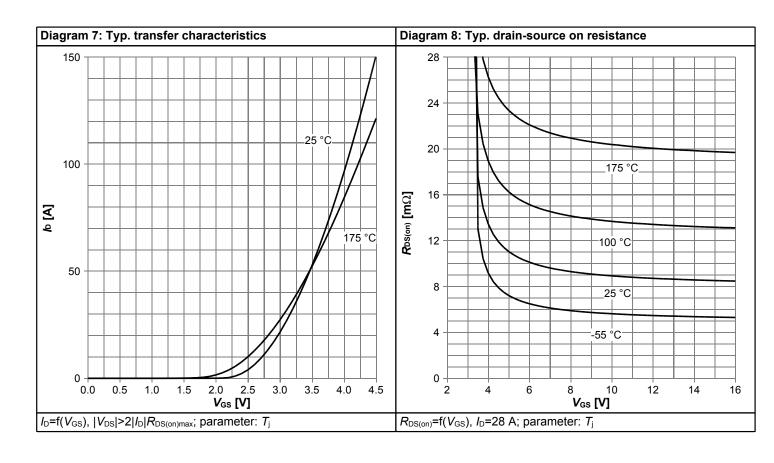
4 Electrical characteristics diagrams



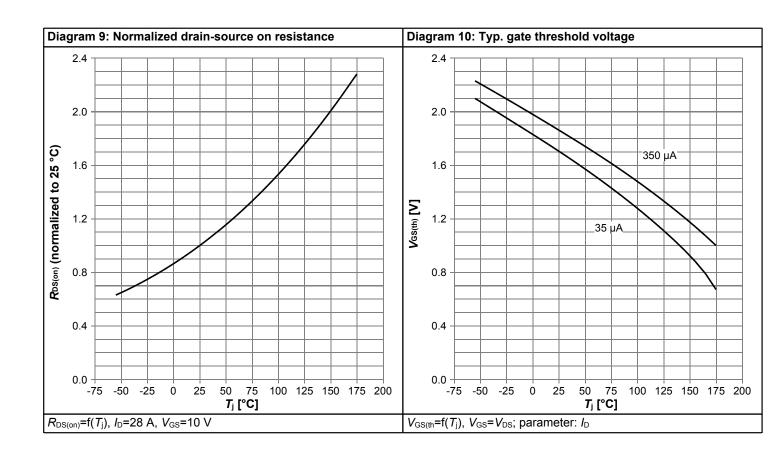


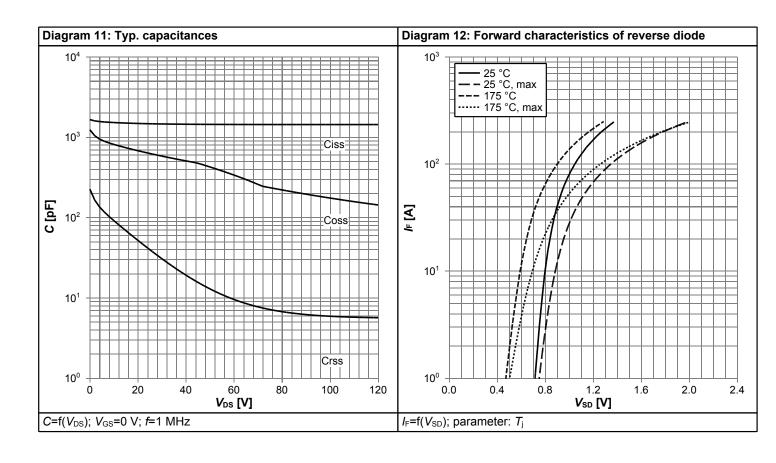




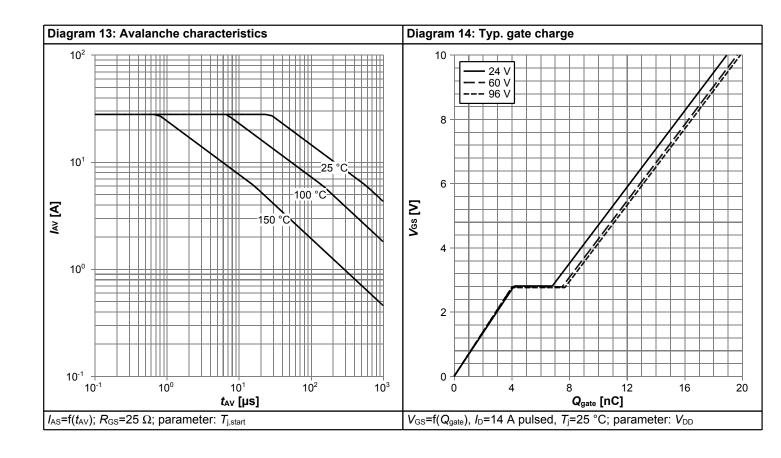


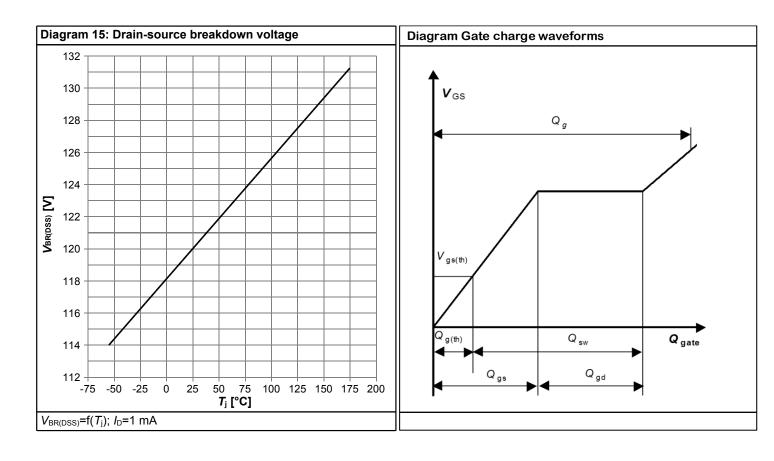






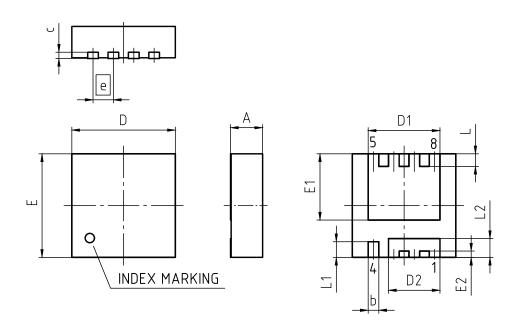








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-TSDS	SON-8-U03			
REVISION: 03	DATE:	20.10.2020			
DIMENSIONS	MILLIN	IETERS			
DIMENSIONS	MIN.	MAX.			
Α	0.90	1.10			
b	0.24	0.44			
С	(0.	20)			
D	3.20	3.40			
D1	2.19	2.39			
D2	1.54	1.74			
E	3.20	3.40			
E1	2.01	2.21			
E2	0.10	0.30			
е	0.65				
L	0.30	0.50			
L1	0.40	0.60			
L2	0.50	0.70			
aaa	0.0	06			

Figure 1 Outline PG-TSDSON-8, dimensions in mm/inches

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Revision History

ISZ106N12LM6

Revision: 2022-12-13, Rev. 2.0

Previous R	Previous Revision						
Revision	Date	Subjects (major changes since last revision)					
2.0	2022-12-13	Release of final version					

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